

DOCKET NO: 295408US40PCT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
DAISUKE HIROKANE : EXAMINER: FEELY, MICHAEL J
SERIAL NO: 10/594,322 :
FILED: JANUARY 17, 2007 : GROUP ART UNIT: 1796
FOR: EPOXY RESIN COMPOSITION :
FOR THE ENCAPSULATION OF
SEMICONDUCTORS AND
SEMICONDUCTOR DEVICES

AMENDMENT

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated April 3, 2009, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.